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# **F<sup>2</sup>MC-8FX FAMILY**

## **8-BIT MICROCONTROLLER**

# **MB95310/370 SERIES**

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# **I2C HARDWARE DESIGN API**

## **APPLICATION NOTE**

## Revision History

Date	Author	Change of Records
2009-11-10	Jane Li	V1.0, First draft

This manual contains 17 pages.

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# 1 Introduction

This document introduces API for I2C hardware design.

I2C is two wires synchronization protocol in device communication, which has bi-directional wires SDA and SCL. In following chapters we will describe the I2C hardware design and protocol.

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## 2 Background

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This chapter introduces the background of I2C.

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Compared with others serial extended interface protocol, the I2C is used widely. I2C bus has standard criterion and multitudinous periphery apparatus.

The I2C interface is a two-wire, bi-directional bus consisting of a serial data line (SDA) and a serial clock line (SCL). The devices connected to the bus via these two wires can exchange data, and each device can operate as a sender or receiver in accordance with their respective functions based on the unique address assigned to each device.

Following are some features of I2C:

- integrated Criterion
- independent Structure
- Easy to use

When I2C is used, typical use module of SCM is a small system. It can include I/O, keyboard, display module, clock, A/D, data storage and so on. For what the software become easy and content become more abundance.

### 3 Description of I2C Protocol

This chapter describes protocol of I2C.

In I2C bus, SCL generates clock and SDA reloads data out and in. Figure 3-1 simply describes I2C protocol.

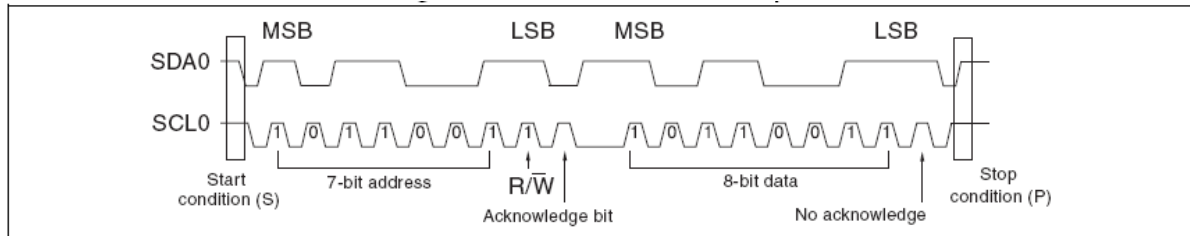


Figure 3-1: I2C Protocol

The slave address is transmitted after a start condition (S) is generated.

Data is transmitted after the address. Data can be transmitted continuously to the same slave address.

The data is eight bits followed by an acknowledgment.

Data transfer is always ended in the master stop condition (P). However, the repeated start condition can be used to transmit the address which indicates a different slave without generating a stop condition.



### 3.1 Start Condition

When bus is free, change SDA from high to low while SCL is high will generate a start signal. In MB95F310 writing "1" to register IBCR10\_MSS and ICCR0\_EN will generate a start signal. Detailed start status refer to Figure 3-2.

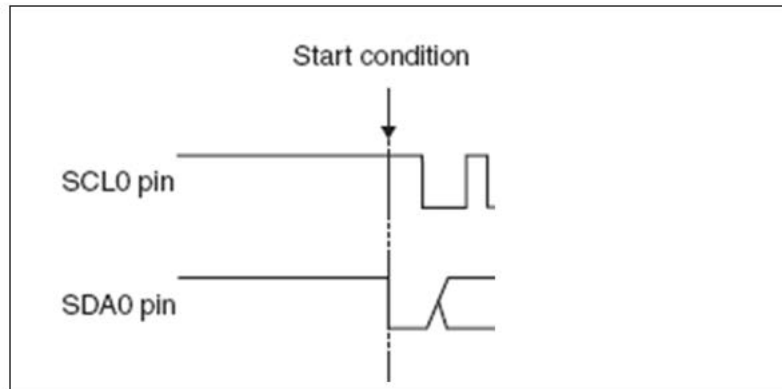


Figure 3-2: Status of Starting  
Start signal can generate again when writing "1" to MCU register IBCR10\_SCC.

### 3.2 Address

This address is seven bits followed by the data direction bit (R/W) in the eighth bit position. About the direction, "0" is writing and "1" is reading

In MB95F310 MCU master mode slave address is written to register IDDR0, when start signal generated data of IDDR0 send out to slave device.

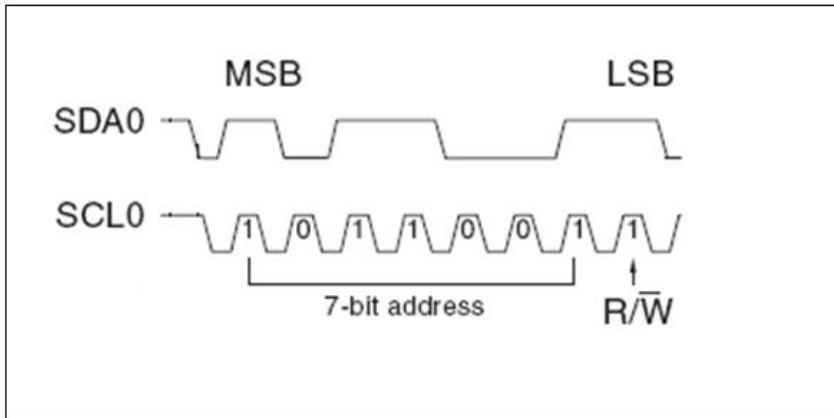


Figure 3-3: Status of Address

### 3.3 Acknowledge

Acknowledge is generated when slave device received address or data. Acknowledge is low level when SCL is in the ninth pulse.

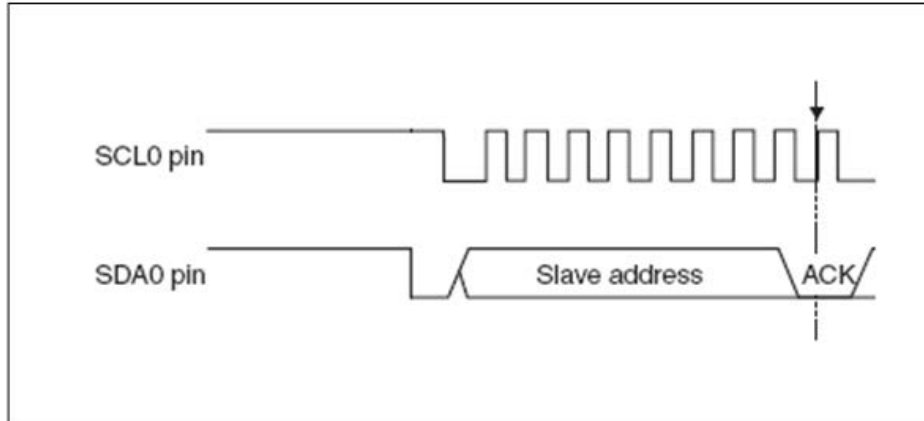


Figure 3-4: Status of Acknowledge

If the SDA is high at the ninth pulse, which indicates that the slave device didn't receive the address or data from master device.

### 3.4 Data

Whatever writing to/reading from slave device the data is eight bits. Only when master device received the acknowledge data can transmitted out. In MB95F310 MCU the register IDDR0 is used to save the data.

### 3.5 Stop Condition

When SCL is high, changing SDA from low to high will generate a stop signal. In MB95F310 MCU writes "0" to register IBCR10\_MSS will generate a stop signal.

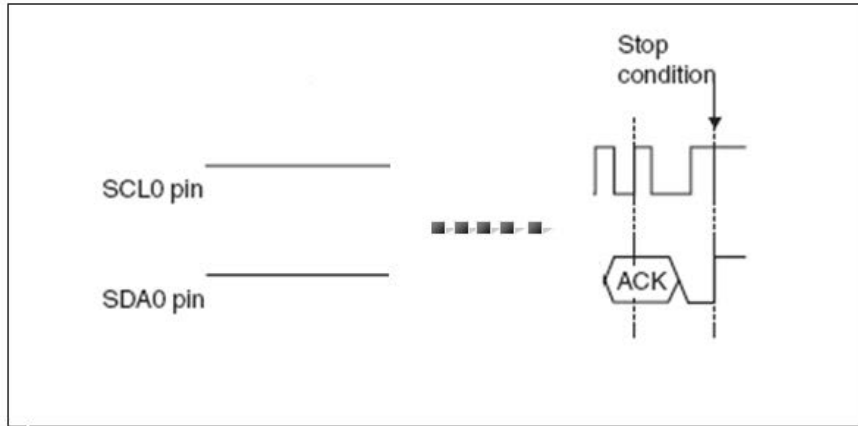


Figure 3-5: Status of Stop

## 4 I2C Hardware Design

This chapter describes hardware design of I2C.

### 4.1 Hardware Design

Actually, I2C is two wires, which are SDA and SCL. Master SDA is connected with slave SDA, and master SCL is connected with slave SCL. Figure 4-1 describes the hardware connection in detailed.

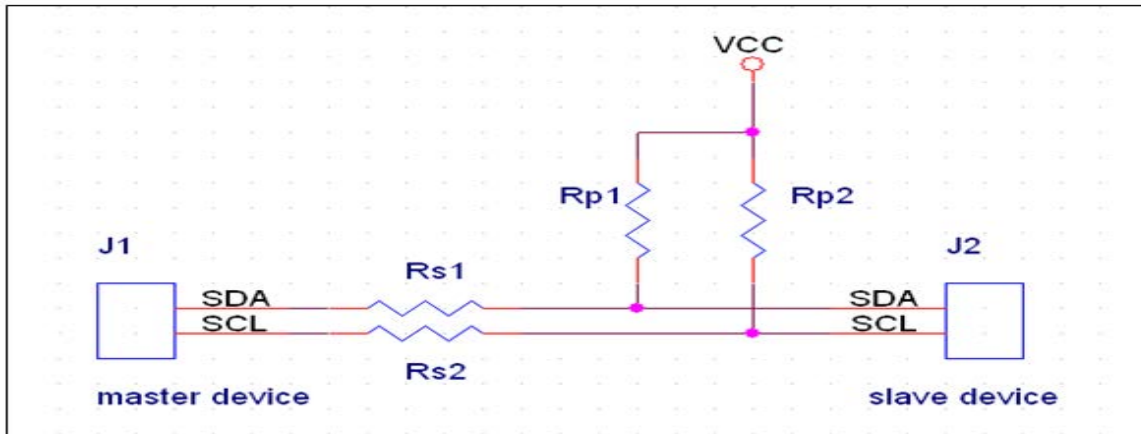


Figure 4-1: I2C Hardware Design

## 4.2 Pull Up Resister

Because the start signal is generated when SCL is high, so user must connect pull up resister to I2C.

The pull up resister is restricted by power voltage. That is because when voltage  $V_{OLMAX}$  is 0.4V, the Min current must be 3mA. Figure 4-2 describes the relationship between power voltage  $V_{DD}$  and pull up resister  $R_P$ , pull up resister  $R_P$  and  $R_S$ .

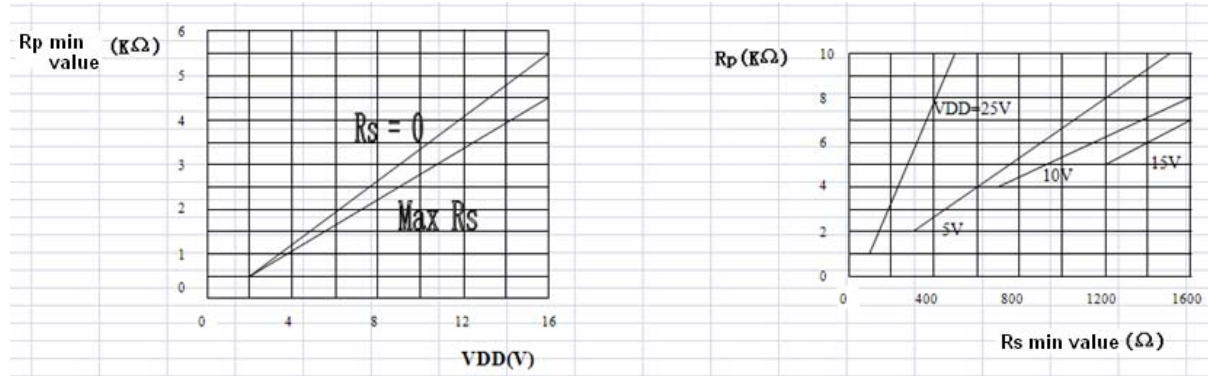


Figure 4-2: Resister of Pull Up

### 4.3 I2C Electronic Character

In order to guarantee I2C transmitting from error, I2C timing is restricted strictly. Table 4 – 1 is I2C bus timing character.

Table 4-1: I2C Timing

Parameter	Standard Mode		High Speed Mode		Unit
	MIN	MAX	MIN	MAX	
SCL Frequency	0	100	0	400	kHz
Vacant time between first stop signal and second start signal	4.7	-	1.3	-	μs
Start holding time	4	-	0.6	-	μs
SCL cycle of low level	4.7	-	1.3	-	μs
SCL cycle of high level	4	-	0.6	-	μs
Building time of double start signal	4.7	-	0.6	-	μs
Data building time	250	-	100	-	ns
Rising time of SDA and SCL	-	1000	20	300	ns
Dropping time of SDA and SCL	-	300	20	300	ns
Building time of stop signal	4	-	0.6	-	μs
Reload Capacity of every transmitting	-	400	-	400	pF

About the speed of I2C data transmission it is decided by SCL high level voltage and low level voltage. In actually the transmitting speed can be modified by adding delay for SCL.

## 5 Usage Demo

This chapter describes the I2C wave and I2C multi connection.

In I2C transmitting the signal is transferred synchronously. Figure 5 - 1 shows the status when bit transferring.

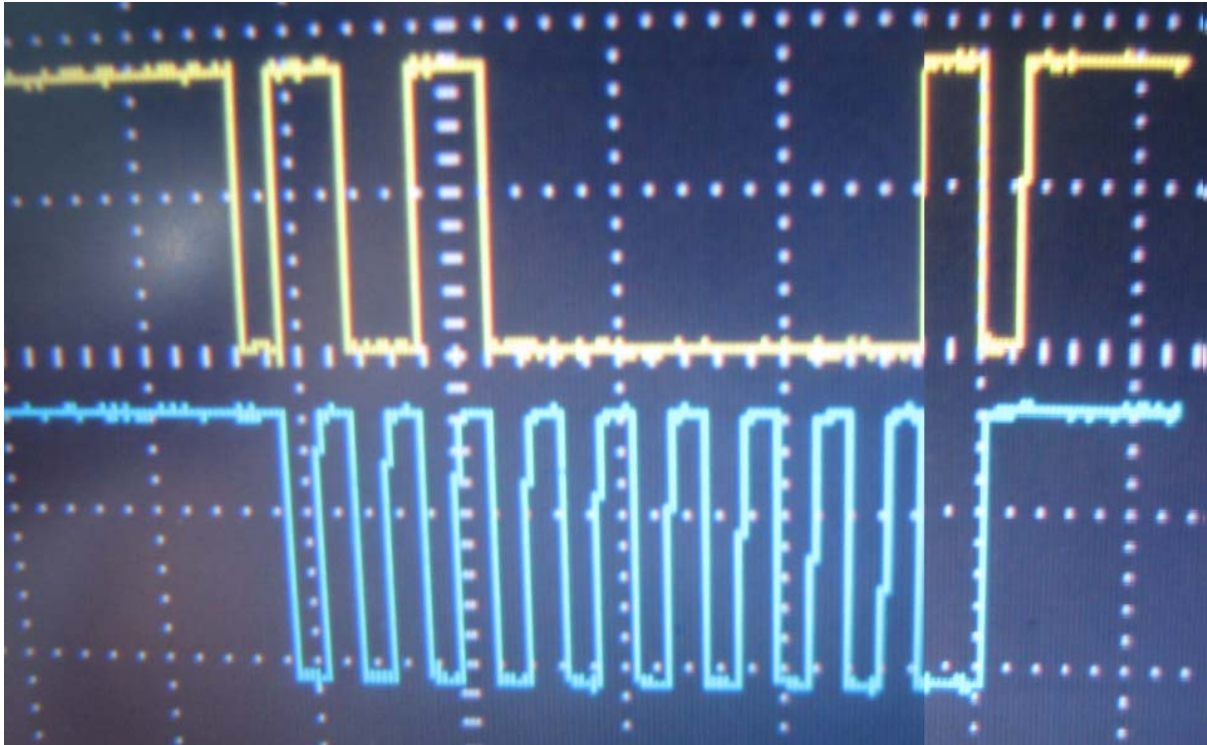


Figure 5-1: I2C Wave

The yellow wave is SDA which transfers data. The blue wave is SCL which transfers clock.

This wave displays the start condition, data transfer condition, acknowledge generate condition, and stop condition.



One master I2C device can control several I2C devices. Every slave device has only address. When the slave device received the address which is same as itself, the slave device generates acknowledge to master, and then begin to receive data.

Figure 5 – 2 describes the situation when one master controls several slave device.

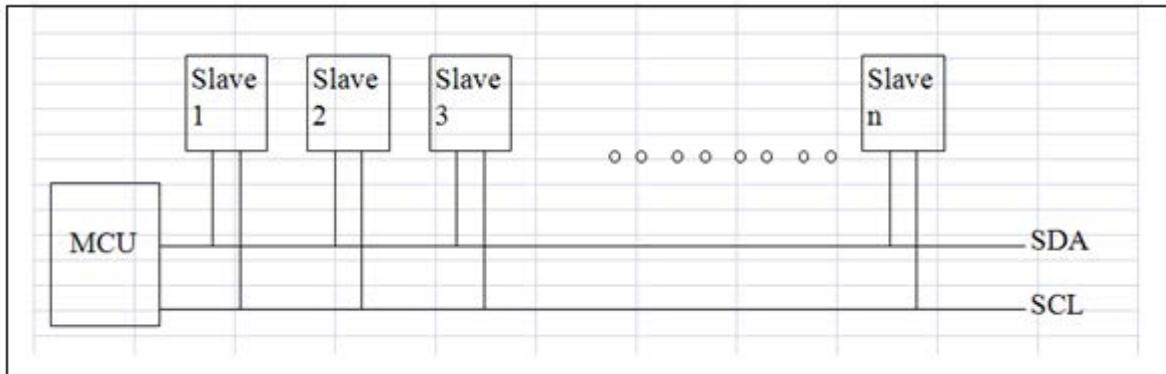


Figure 5-2: I2C Multi-connection

## 6 Additional Information

For more information about how to use MB95310 EV-board, BGM Adaptor and SOFTUNE, please refer to EV-Board MB2146-450-E User Manual, or visit websites:

English version:

[http://www.fujitsu.com/cn/fsp/services/mcu/mb95/application\\_notes.html](http://www.fujitsu.com/cn/fsp/services/mcu/mb95/application_notes.html)

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